



REV.	ECN NO.	REVISED	DATE

NOTE:

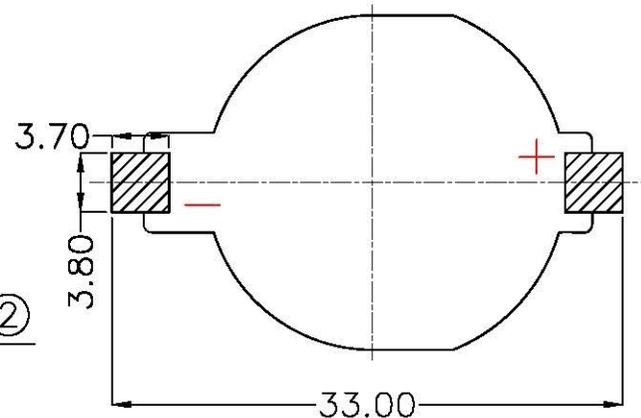
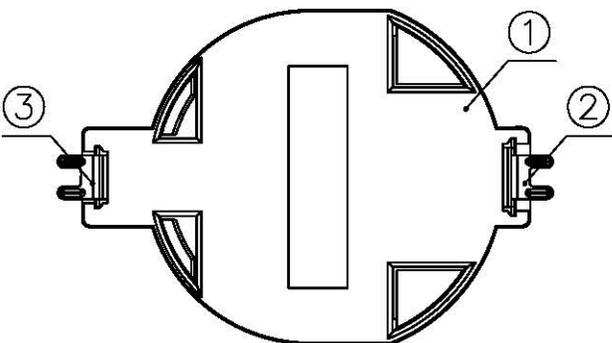
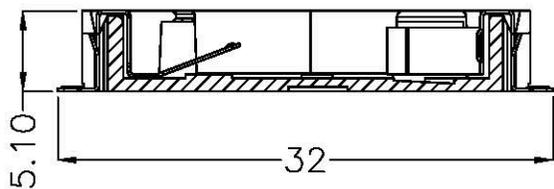
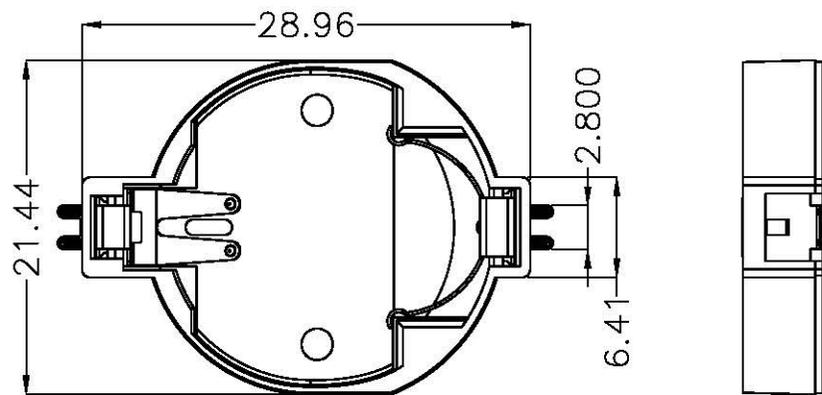
1.MATERIAL:

- a.HOUSING:PPS UL94V-0
- b.CONTACT:PHOSPHOR BRONZE
(SURFACE PLATING: Au1u")

SEE ORDERING INFORMATION

2.ELECTRIC:

- a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
- b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN
- c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL
- d.OPERATING TEMPERATURE: -25° C~ +85° C



PCB Layout Diagram
Top View

ORDERING INFORMATION

F-10-B***010

電池盒系列

F-10系列

SMT 180° TYPE

PLATING:

- A-Au1U"
- J-Ni100U"~120U"
- K-Sn100U"~120U"

MATERIAL:

- 1A-PBT BLACK
- 1B-PA66 BLACK
- 2A-PPA BROWN
- 2B-PPA BLACK
- 3A-PPS BROWN
- 3B-PPS BLACK
- 4A-LCP WHITE
- 4B-LCP BLACK



NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR
3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
1	HOUSING	1	PPS	BROWN

UNLESS OTHERWISE SPECIFIED TOLERANCES		FLYING INTERNATIONAL 汎翊國際有限公司	
DECIMALS: X :±0.30 X.X :±0.25 X.XX :±0.20 X.XXX :±0.10	ANGLES: X :±1° X.X :±0.5°	DSND YangFeng	DATE 2017-07-13
WEIGHT: 1.21g		CHKD ZhouRuicai	DATE 2017-07-13
SHEET 1 OF 1		APVD XueShunyong	DATE 2017-07-13
UNIT: mm	REV.: A/0	SCALE: 2:1	SIZE: A4
OBJECT: MY	DRAW NO.:MY-CP-0003	VIEW:	TITLE: F-2032-10 Sony SMT
			PART NO.: F-10-B3AA010